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Attorney Docket : 033082 M 506

1. Name of conveying party(ies):

Hideo FUNAKOSHI
Masahito HAMADA
Yoshiki OKAMOTO

Additional name of conveying party(ies) attached? Yes No

2. Name and address of receiving party(ies)

Name: Tokyo Electron Limited

Street Address: 3-6, Akasaka 5-Chome

Minato-Ku, Tokyo 107-8481, Japan

Additional Name(s) & address(es) attached? Yes No

3. Nature of conveyance:

- Assignment Merger
- Security Agreement Change of Name
- Other _____

Execution Date: December 17, 2007

4. Application number(s) or patent number(s):



This document is being filed together with a new application.

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning this document should be mailed:

Name: Michael A. Makuch

Internal Address: SMITH, GAMBRELL & RUSSELL, LLP

Street Address: 1130 Connecticut Avenue - Suite 1130

City: Washington State: DC Zip: 20036

6. Total number of applications and patents involved: - 1 -

7. Total fee (37 CFR 3.41) \$40.00

- Enclosed
- Authorized to be charged to deposit account

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02-4300

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Michael A. Makuch

Name of Person Signing

Signature

January 8, 2008

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**UNITED STATES PATENT RIGHTS, OR
UNITED STATES PLUS ALL FOREIGN PATENT RIGHTS**

ASSIGNMENT

Application No. _____ Filed _____

Insert Name(s)
of Inventor(s)

→ WHEREAS, Hideo FUNAKOSHI, Masahito HAMADA and Yoshiki OKAMOTO

Insert Title
of Invention

(hereinafter designated as the undersigned) has (have) invented certain new and useful improvements in

→ Development Processing Device

for which an application for Letters Patent of the United States of America has been executed by the undersigned (except in the case of a provisional application).

Insert Date of
Signing of
Application

→ on December 17, 2007 ; and

Insert Name
of Assignee

→ WHEREAS, TOKYO ELECTRON LIMITED

Insert Address
of Assignee

→ of 3-6, Akasaka 5-chome, Minato-ku, Tokyo 107-8481 Japan

CHECK BOX
IF APPROPRIATE

its heirs, successors, legal representatives and assigns (hereinafter designated as the Assignee) is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent(s) that may be granted therefor in the United States of America and
→ in any and all foreign countries.

NOW, THEREFORE, in consideration of the sum of Ten Dollars (\$10.00) to the undersigned in hand paid, the receipt of which is hereby acknowledged, and other good and valuable consideration the undersigned has (have) sold, assigned and transferred, and by these presents does sell, assign and transfer unto said Assignee the full and exclusive right to the said invention in the United States of America, its territories, dependencies and possessions and the entire right, title and interest in and to any and all Letters Patent(s) which may be granted therefor in the United States of America, its territories, dependencies and possessions, and if the box above is designated, in any and all foreign countries:

and to any and all divisions, reissues, continuations, conversions and extensions thereof for the full term or terms for which the same may be granted.

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional, conversion or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division, conversion or reissue thereof or Letters Patent(s) or reissue patent issued thereon and to cooperate with the Assignee in every way possible in obtaining and producing evidence and proceeding with such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims or provisions of the International Convention for the Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States of America patent(s) or a grant of a valid United States of America and any foreign patent(s) to the Assignee and to vest all rights therein hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) the request(s) the Patent and Trademark Office Officials in the United States of America and in any foreign countries to issue any and all Letters Patents resulting from said application or any continuing, divisional, conversion or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the law firm of Smith, Gambrell & Russell, LLP the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

The undersigned hereby covenant(s) that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date <u>December 17, 2007</u>	Name of Inventor <u>Hideo Funakoshi</u> Hideo FUNAKOSHI
Date <u>December 17, 2007</u>	Name of Inventor <u>Masahito Hamada</u> Masahito HAMADA
Date <u>December 17, 2007</u>	Name of Inventor <u>Yoshiki Okamoto</u> Yoshiki OKAMOTO
Date _____	Name of Inventor _____
Date _____	Name of Inventor _____
Date _____	Name of Inventor _____
Date _____	Name of Inventor _____
Date _____	Name of Inventor _____
Date _____	Name of Inventor _____

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